



佛山市国星光电股份有限公司

FOSHAN NATIONSTAR OPTOELECTRONICS CO., LTD

SPECIFICATION

Customer		Product	Chip1206 LED
Customer No.		Type	FC-3215 <u>XXX</u>

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APPROVED SIGNATURES			



Research & Development Center		
APPROVE	CHECK	DRAW
Release Date : 2009-12-21		

FC-3215 XXX

Chip Light Emitting Diode

Technical Data Sheet

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard. And it also be widely used as flat backlight for Liquid Crystal Display (LCD).

Features:

Color	Material
Red	Red-AlGaInP or AlGaAs
Orange	Orange - GaAsP
	Orange -AlGaInP
Yellow	Yellow - GaAsP
	Yellow -AlGaInP
Yellow Green	Yellow Green -GaP
	Yellow Green -AlGaInP
Green	Green-InGaN
Blue	Blue- InGaN
White	Blue- InGaN

- Wide Viewing Angle
- Reflow Solderable
- High and Low Luminous Intensity and Low Power Dissipation
- Good Reliability and Long Life
- Complied With RoHS Directive

Electrical Characteristics

◇ Absolute Maximum Ratings (Temperature=25°C):

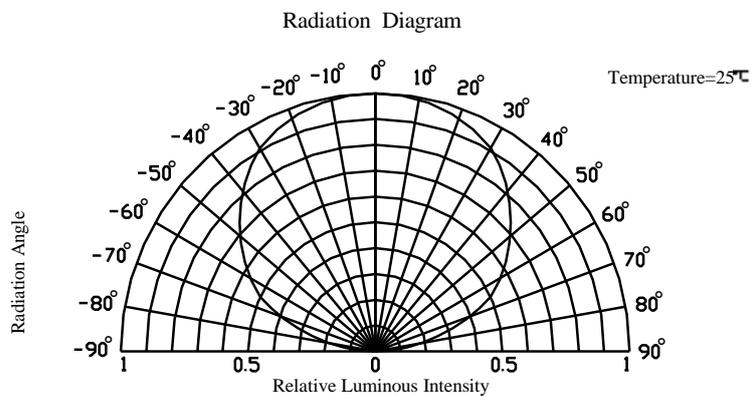
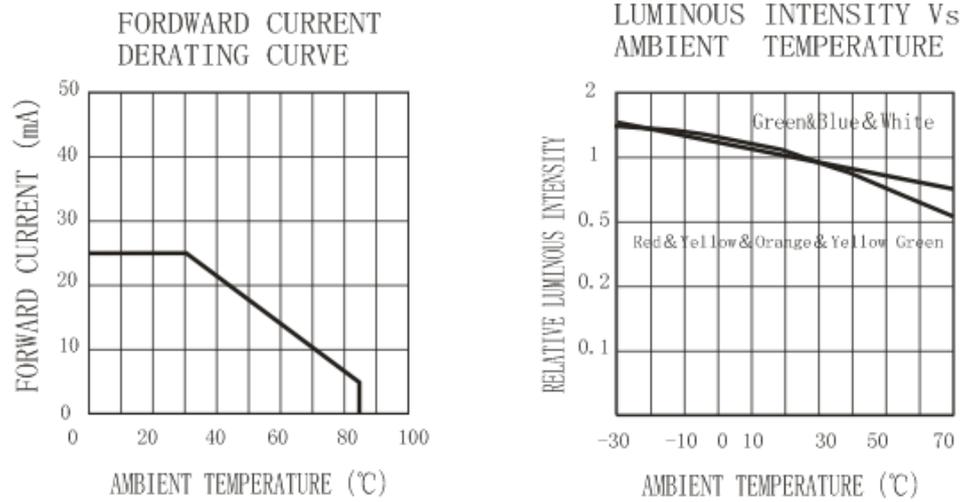
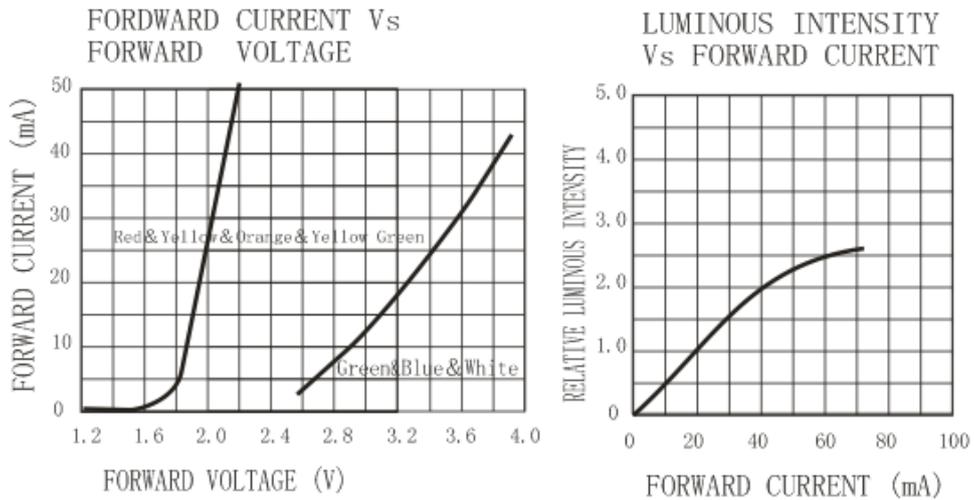
Parameter	Symbol	Rating	Unit	
Forward Current	I_F	25 Max.	mA	
Pulse Forward Current*	I_{FP}	100 Max.	mA	
Reverse Voltage	V_R	5 Max.	V	
Operating Temperature	T_{OPR}	-30 ~ +85	°C	
Storage Temperature	T_{stg}	-40 ~ +100	°C	
Power Dissipation	P_D	R	75 MAX	mW
		O		
		Y		
		YG		
		G	120 MAX	
		B		
		W		

● Note: Pulse width $\leq 0.1ms$, Duty $\leq 1/10^*$

✧ Electro-Optical Characteristics (Temperature=25°C):

Part Number	EMITTED COLOR	Lens Color	Dominant Wavelength (nm)	IV(If=20mA) mcd		Vf (v) Typ	View Angle 2θ1/2	
				Min.	Typ.			
FC-3215HRK-660*	Super Red	Water	645	8	14	2.0	130	
FC-3215HRK-620D			620	45	80			
FC-3215SXX-620H08		Clear	620	120	180			
FC-3215SXX-630D08			630	60	80			
FC-3215HOK-605C			Super Orange	605	45			80
FC-3215YOXK-600H08				604	120			180
FC-3215YK	Yellow	Water	589	7	10	2.0	130	
FC-3215YXK-585F08	Super Yellow		588	45	80			
FC-3215YXK-585H08			589	100	150			
FC-3215HYK-589N			589	200	350			
FC-3215PGK	Green	Water	560	7	10	2.0	130	
FC-3215GHK-570A08	Yellow		570	18	30			
FC-3215GEK-572E	Green		572	30	60			
FC-3215UGK-520D	Super Green	Clear	520	400	500	3.2	130	
FC-3215UGK-520H			520	500	750			
FC-3215BXK-465D	Super Blue		465	80	100	3.2	130	
FC-3215BK-470M			470	100	150			
FC-3215WD-460K	Super White	Yellow diffused	7500-12000K	400	550	3.2	130	
FC-3215SQGIBIK	Tri-Color	Water	R:625	120	150	2.0	130	
			G:520	400	500	3.2	130	
			B:470	80	100	3.2	130	

Typical Characteristics Curves



Reliability Test Items And Conditions

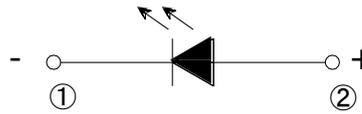
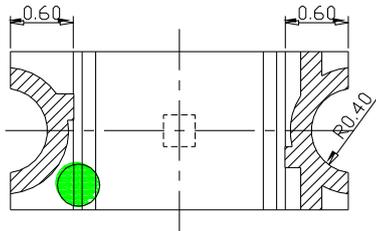
Test Items	Test Conditions	Quantity	Judging Criteria
Solderability	Solder Temperature: 300°C Solder Duration: (3.5±0.5) sec.	15	Solderable Area Over 95%
Thermal Shock Followed by High Temperature And High Humidity Cyclic	-40°C → 10 min. 5 Cycles  Shift (2~3) min. 100°C → 10 min.  25°C~55°C (90%~95%) RH 2 Cycles for 48 hrs., Recover for 2 hrs.	11	C=0 & I**
Resistance For Soldering Heat	Reflow Soldering	15	C=0 & I**
DC Operating Life	1000 hrs. Forward Current: 25mA	22	C=0 & I*
High Temperature Storage	100°C → 1000 hrs.	15	C=0 & I*
High Temperature And High Humidity Cyclic	25°C~55°C (90%~95%) RH 6 Cycles for 144 hrs., Recover for 2 hrs.	11	C=0 & I*

*1 Criteria For Judging Damage

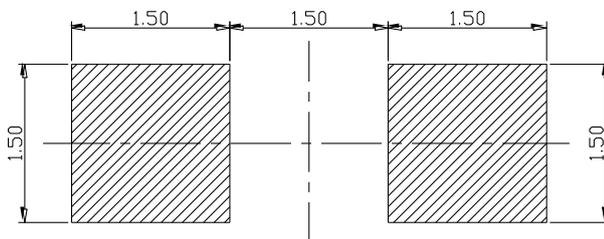
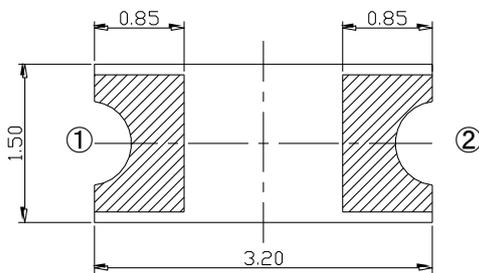
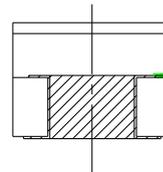
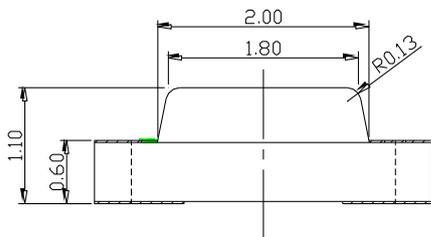
Items	Symbol	Test Conditions	Criteria For Judging Damage I*	Criteria For Judging Damage I**
Forward Voltage	V _F	I _F =20mA	≥USL×1.2	≥USL
Reverse Current	I _R	V _R =5V	≥USL×2.0	≥USL
Luminous Intensity	I _V	I _F =20mA	≤LSL×0.5	≤LSL

* USL: Upper Standard Level, LSL: Lower Standard Level *

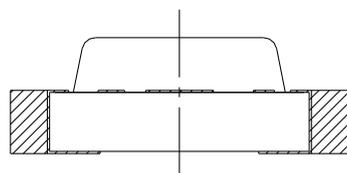
Outline Dimensions



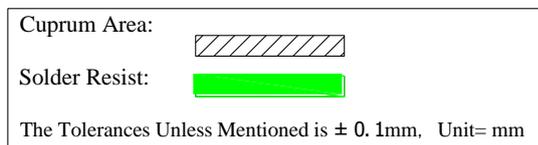
Polarity



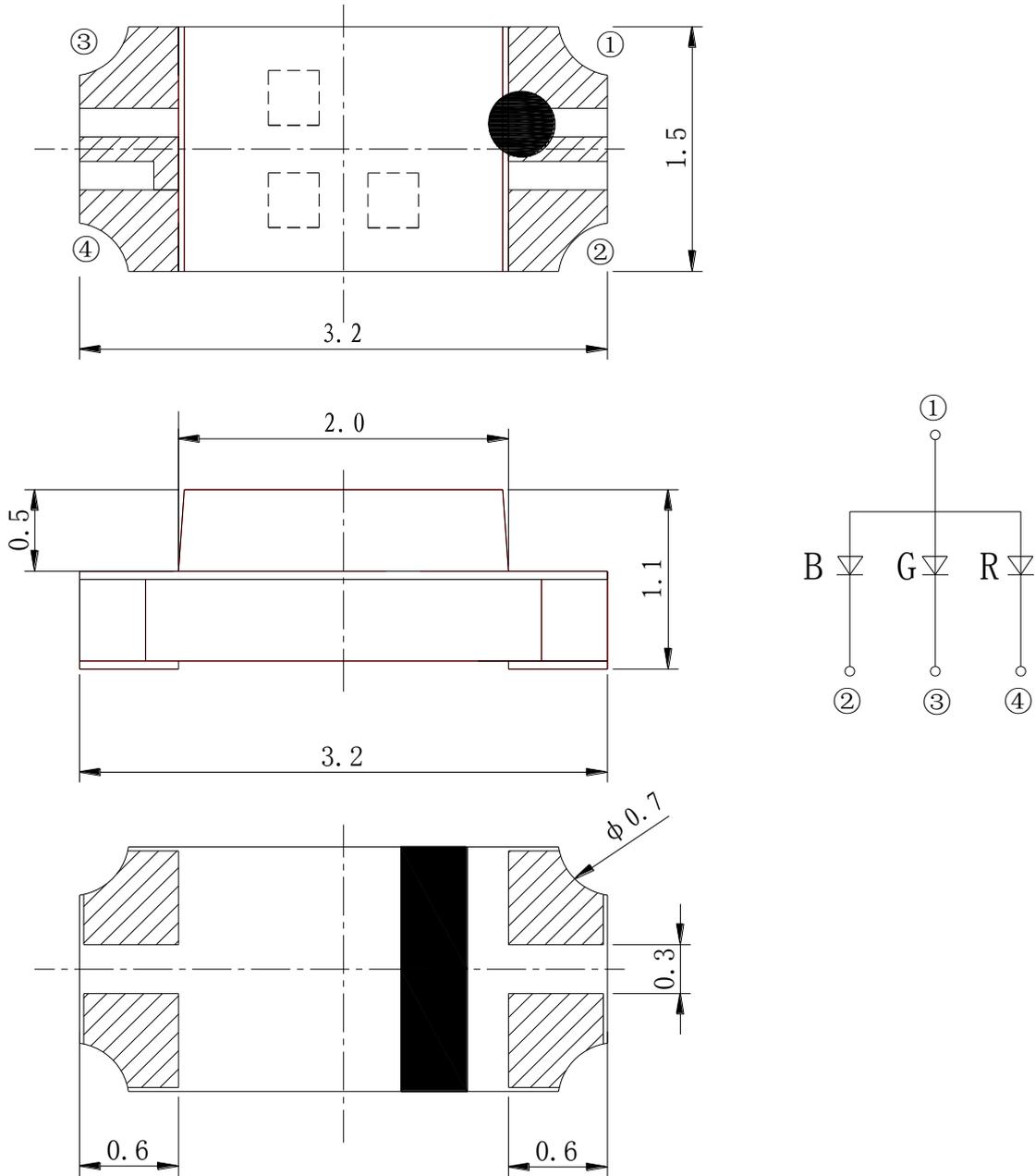
Recommended Soldering Pad



Section View



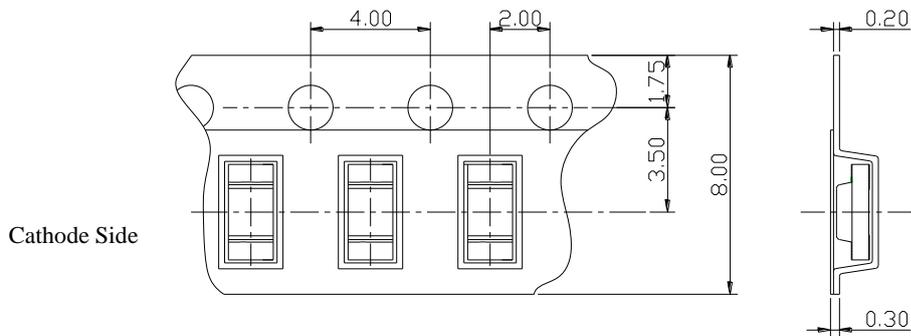
Single Color



Tri Colors

Packaging (1)

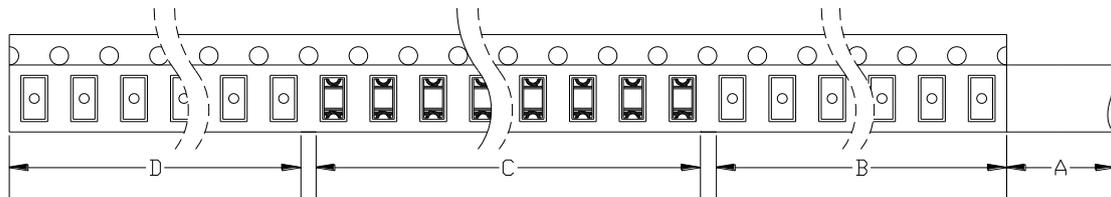
✧ Carrier Tape



All dimensions in mm, tolerances unless mentioned is ± 0.1 mm.

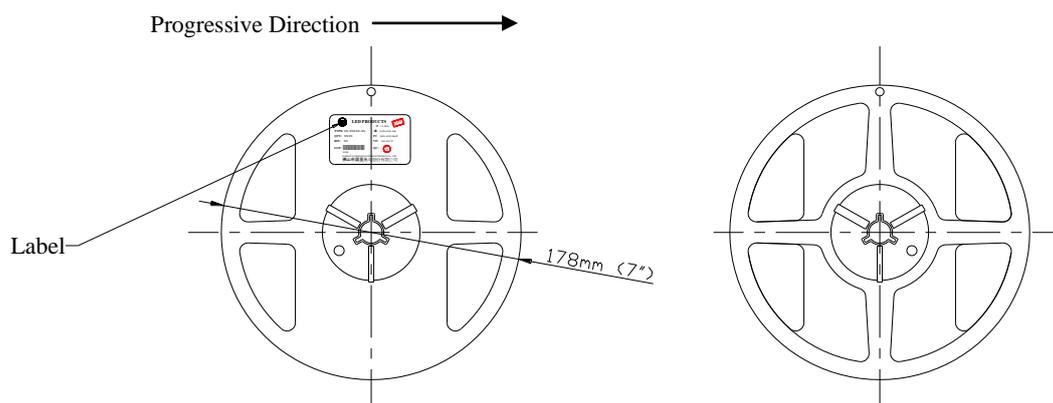
✧ Details Of Carrier Tape

前进方向 Progressive Direction →



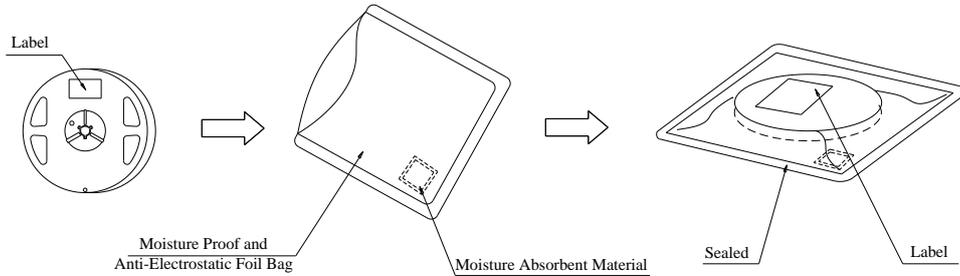
A: Top Cover Tape, 300mm; B: Leader, Empty, 200mm; C: 3000 Lamps Loaded; D: Trailer, Empty, 200mm.

✧ Reel Dimension

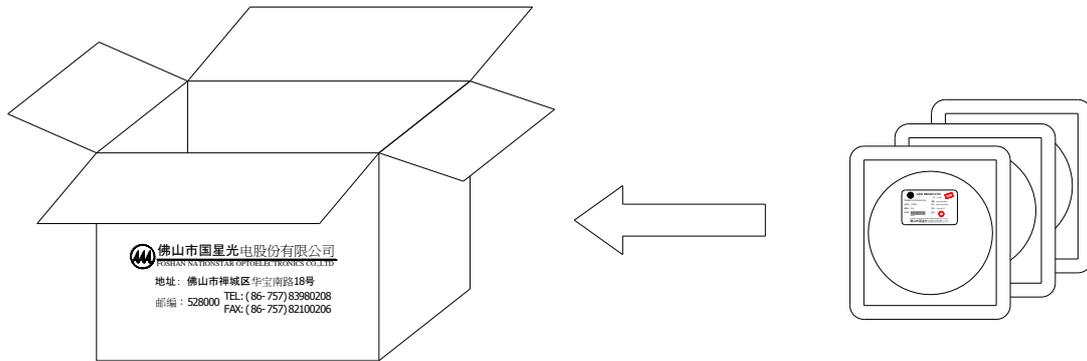


Packaging (2)

✧ Moisture Proof and Anti-Electrostatic Foil Bag



✧ Cardboard Box



✧ Label Explanation

QTY: Quantity

BIN: Rank

LOT: Lot Number

λd: Wavelength Range

IV: Luminous Intensity Range

VF: Forward Voltage Range

IF: Testing Current



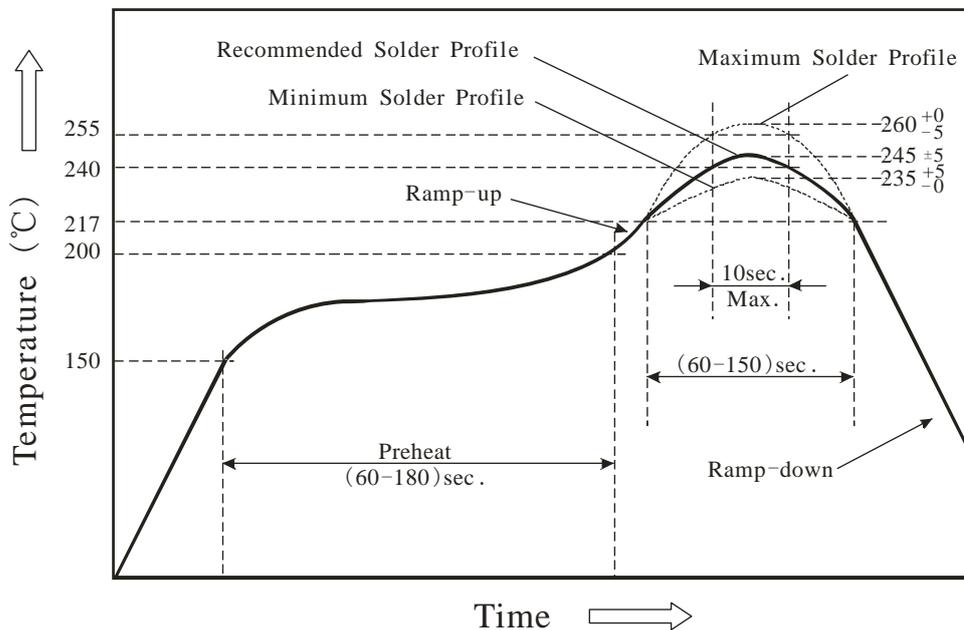
Guideline for Soldering

1. Hand Soldering

A soldering iron of less than 20W is recommended to be used in Hand Soldering. Please keep the temperature of the soldering iron under 300°C while soldering. Each terminal of the LED is to go for less than 3 second and for one time only.

Be careful because the damage of the product is often started at the time of the hand soldering.

2. Reflow Soldering: Use the conditions shown in the under Profile of Pb-Free Reflow Soldering.



- Reflow soldering should not be done more than two times.
- Stress on the LEDs should be avoided during heating in soldering process.
- After soldering, do not deal with the product before its temperature drop down to room temperature.

3. Cleaning

It is recommended that alcohol be used as a solvent for cleaning after soldering. Cleaning is to go under 30°C for 3 minutes or 50°C for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

Ultrasonic cleaning is also an effective way for cleaning. But the influence of Ultrasonic cleaning on LED depends on factors such as ultrasonic power. Generally, the ultrasonic power should not be higher than 300W. Before cleaning, a pre-test should be done to confirm whether any damage to LEDs will occur.

Note: This general guideline may not apply to all PCB designs and configurations of all soldering equipment. The technique in practice is influenced by many factors, it should be specialized base on the PCB designs and configurations of the soldering equipment.

Precautions (1)

1. Storage

- Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.
- Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and be used within a year.
- After opening the package, the product should be stored at 30°C or less and humidity less than 10%RH, and be soldered within 168 hours (7 days). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: $(60 \pm 5)^\circ\text{C}$ for 24 hours.

2. Static Electricity

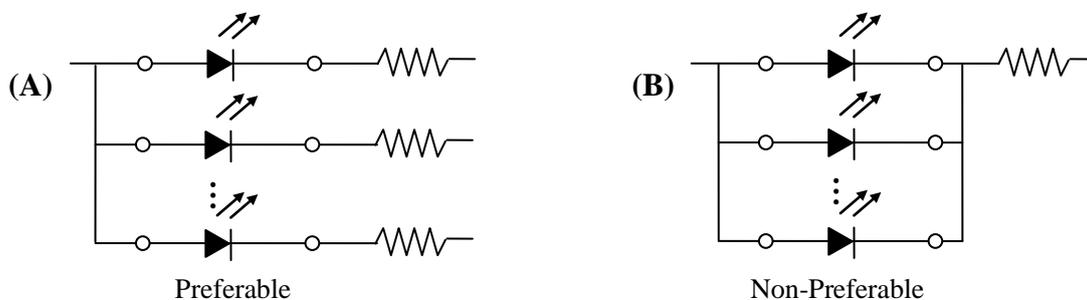
Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current., even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

3. Design Consideration

In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.

It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B. When driving LEDs with a constant voltage in Circuit B, the current through the LEDs may vary due to the variation in Forward Voltage (V_F) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the Absolute Maximum Rating.

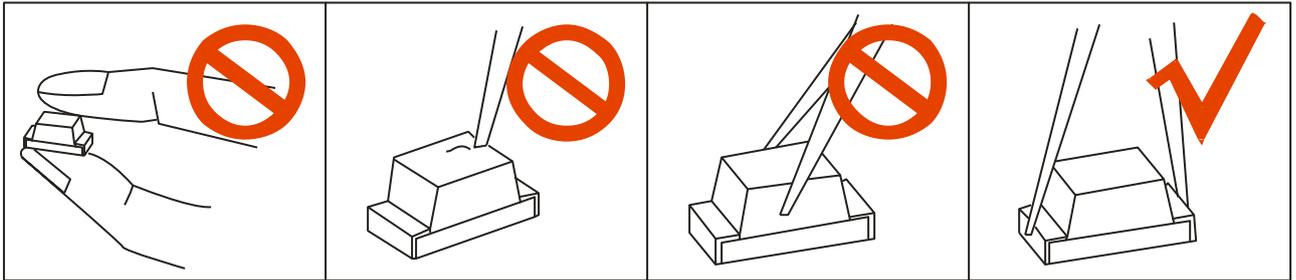


Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color changed and so on. Please consider the heat generation of the LEDs when making the system design.

Precautions (2)

4. Others

When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.

5. Safety Advice For Human Eyes

Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity, will cause great hazard to human eyes. Please be careful.

Appendix

IV(mcd) BINS:

Detailed Bracket			
IV(mcd)	IV(mcd)	IV(mcd)	IV(mcd)
7-9	24-30	80-100	270-330
9-11	30-36	100-120	330-400
11-13	36-45	120-150	400-500
13-16	45-55	150-180	500-600
16-20	55-65	180-220	600-750
20-24	65-80	220-270	750-900

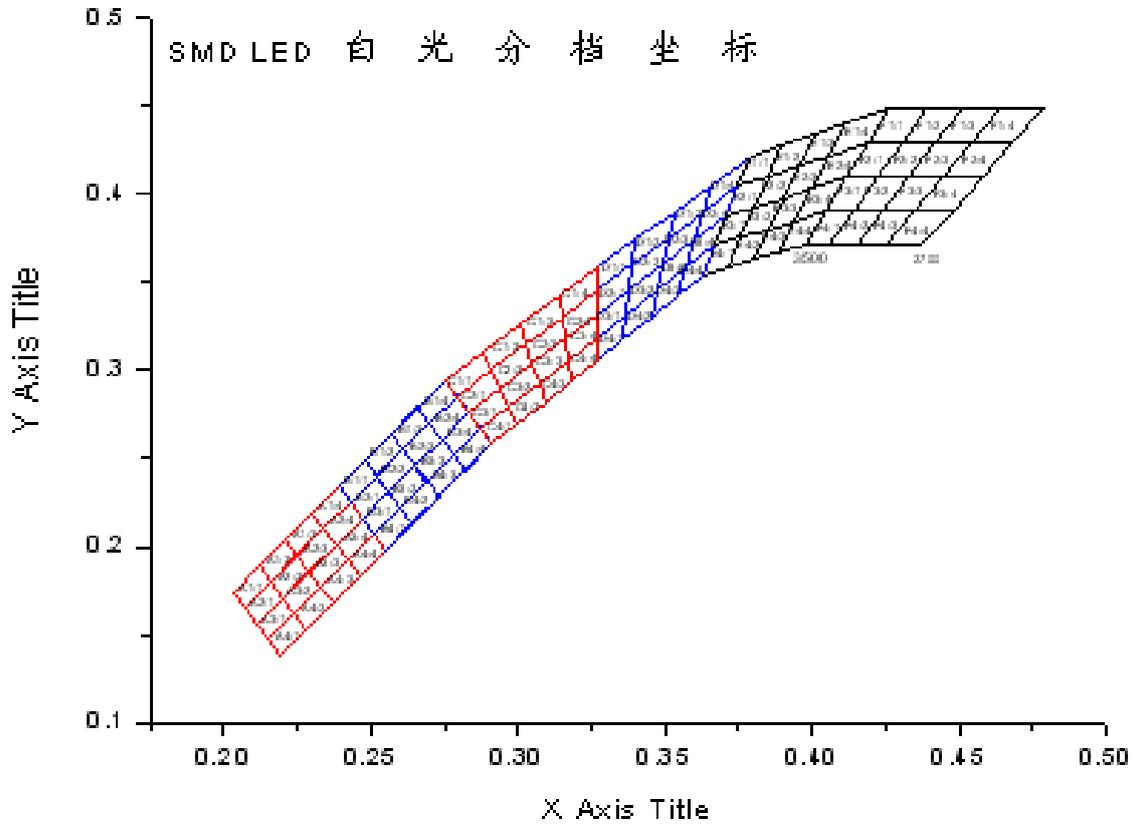
V_F(V) BINS:

Detailed Bracket			
V _F (V)	V _F (V)	V _F (V)	V _F (V)
1.6-1.7	2.2-2.3	2.8-2.9	3.4-3.5
1.7-1.8	2.3-2.4	2.9-3.0	3.5-3.6
1.8-1.9	2.4-2.5	3.0-3.1	3.6-3.7
1.9-2.0	2.5-2.6	3.1-3.2	3.7-3.8
2.0-2.1	2.6-2.7	3.2-3.3	3.8-3.9
2.1-2.2	2.7-2.8	3.3-3.4	3.9-4.0

λ_D (nm) BINS

	λ_D (nm)		λ_D (nm)	
Blue	463-466	Green	515-517.5	527.5-530
	466-469		517.5-520	530-532.5
	469-472		520-522.5	532.5-535
	472-475		522.5-525	
Yellow Green	568-570		525-527.5	
	570-572	Yellow	580-582.5	590-592.5
	572-574		582.5-585	592.5-595
	574-576		585-587.5	
	587.5-590			
Orange	598~601		620~640	
	601~604	Red		
	604~607			
	607~610			

White (X,Y) BINS:



		Bottom	Left	Top	Right			Bottom	Left	Top	Right
A 区 X:0.229 Y:0.186	X	0.219	0.203	0.239	0.255	B 区 X:0.265 Y:0.246	X	0.255	0.239	0.275	0.291
	Y	0.138	0.174	0.234	0.198		Y	0.198	0.234	0.294	0.258
C 区 X:0.305 Y:0.304	X	0.291	0.275	0.327	0.327	D 区 X:0.349 Y:0.36	X	0.327	0.327	0.379	0.363
	Y	0.258	0.294	0.358	0.306		Y	0.306	0.358	0.422	0.354
E 区 X:0.39 Y:0.398	X	0.363	0.379	0.426	0.398	F 区 X:0.433 Y:0.41	X	0.398	0.426	0.479	0.437
	Y	0.354	0.422	0.448	0.372		Y	0.372	0.448	0.448	0.372
When the Label is printed Please give clear indication of color coordinate area (as: A1-2)											

Notes: Measurement Condition: $I_F=20\text{mA}$